

Supplementary Information for
Temperature-induced nanostructural evolution of hydrogen-rich voids in
amorphous silicon: A first-principles study

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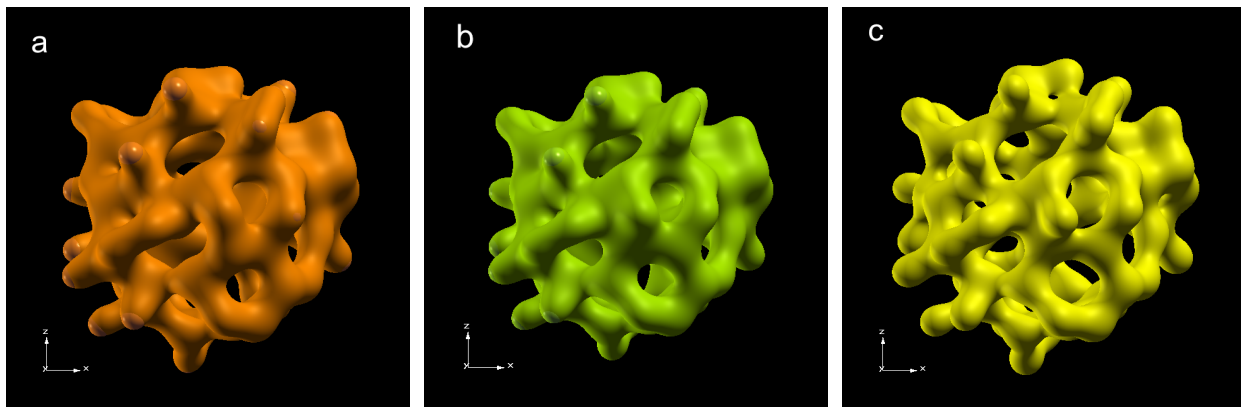


FIG. 1. A three-dimensional representation of the isosurface of a void obtained from: (a) Harris + LDA; (b) SCF + LDA; and (c) SCF + GGA. The last calculation was conducted using double-zeta (DZ) basis functions for Si atoms. The SCF + GGA yields a slightly open structure of the void, as can be seen from (c). The isosurfaces are constructed using an identical set of visualization parameters.

TABLE I. Comparison of void properties from a 1000-atom model of a -Si using Harris + LDA, SCF + LDA, and SCF + GGA. R_{Si} and θ indicate the average Si-Si nearest-neighbor distance and bond angle on the reconstructed surface of a void of radius 5 Å. R_X and Φ_S are the estimated linear size from the gyration radius ($X = g$) and the convex-hull ($X = H$) approximation, and the sphericity of the void.

System	Basis (Si, H)	R_{Si} (Å)	θ (degree)	R_g (Å)	R_H (Å)	V_H (Å ³)	Φ_S
Harris + LDA	SZ, DZP	2.443 ± 0.069	108.407 ± 17.06	6.35	7.12	1245	0.61
SCF + LDA	SZ, DZP	2.453 ± 0.082	108.517 ± 18.56	6.31	7.13	1244	0.62
SCF + GGA	DZ, DZP	2.457 ± 0.084	109.307 ± 17.58	6.28	7.15	1251	0.59

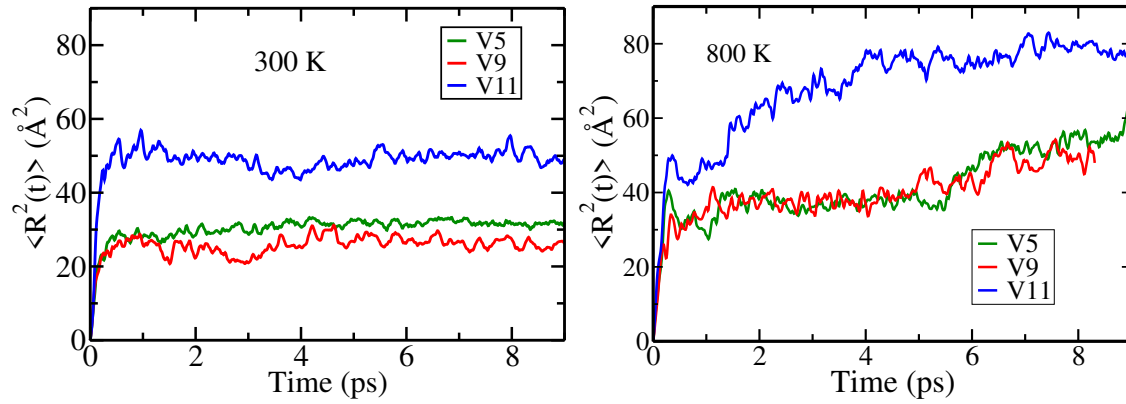


FIG. 2. The time evolution of the mean-square displacement (MSD) of hydrogen atoms inside three voids V5, V9 and V11 at 300 K (left) and 800 K (right) for a period of 8 picoseconds (ps).

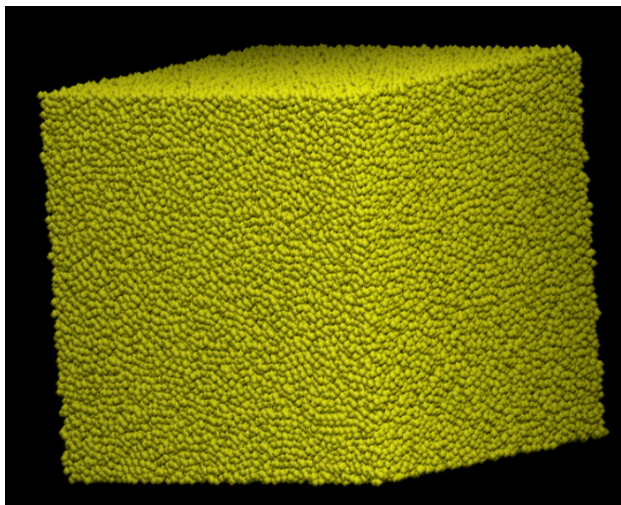


FIG. 3. The large atomistic model with 262, 400 Si atoms, which was used to generate SAXS data by introducing 12 nanometer-size voids of diameter 12 Å. The size of the model is found to be too large to render as a conventional ball-and-stick model.